

# **FDD4N60NZ** N-Channel MOSFET 600V, 3.4A, 2.5Ω

## Features

- $R_{DS(on)}$  = 1.9 $\Omega$  (Typ.)@  $V_{GS}$  = 10V,  $I_D$  = 1.7A
- Low Gate Charge (Typ. 8.3nC)
- Low C<sub>rss</sub> (Typ. 3.7pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant



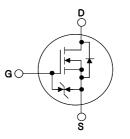


# Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





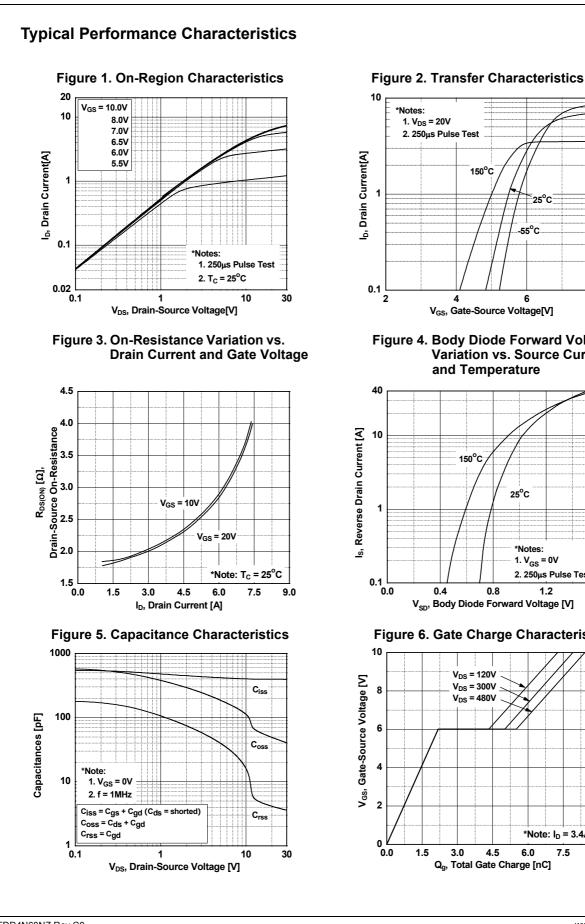
### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter	FDD4N60NZ	Units		
V <sub>DSS</sub>	Drain to Source Voltage		600	V		
V <sub>GSS</sub>	Gate to Source Voltage		±25	V		
	Drain Current	-Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		3.4	A	
ID		-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		2	A	
I <sub>DM</sub>	Drain Current	- Pulsed	13.6	A		
E <sub>AS</sub>	Single Pulsed Avalanche Energy (1		(Note 2)	179.2	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	3.4	A		
E <sub>AR</sub>	Repetitive Avalanche Energ	(Note 1)	11.4	mJ		
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	5	V/ns	
P <sub>D</sub>	Dewer Dissingtion	(T <sub>C</sub> = 25°C)		114	W	
	Power Dissipation	- Derate above 25°C		0.9	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Terr	-55 to +150	°C			
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

### **Thermal Characteristics**

Symbol	Parameter	FDD4N60NZ	Units	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case 1.1			
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	110	°C/W	

Device Ma	Device Marking Device Pack		Package	ige Reel Size Tape			e Width		Quantity		
FDD4N6	-		D-PAK				6mm 2500				
Electrica	l Char	acteristics T <sub>c</sub> =	25°C unless ot	therwise n	oted						
Symbol		Parameter			est Conditions	6	Min.	Тур.	Max.	Unit	
Off Charac	teristic	S									
BV <sub>DSS</sub>	Drain to	Source Breakdown V	oltage I	ר = 250uA	, V <sub>GS</sub> = 0V, T <sub>J</sub>	= 25°C	600	-	-	V	
ΔBV <sub>DSS</sub>		an to Source Breakdown Voltage						0.6		V/°C	
$\Delta T_{J}$	Coeffici	ent		$I_D$ = 250µA, Referenced to 25°C			-	0.6	-	v/ C	
I <sub>DSS</sub>	Zero Ga	ate Voltage Drain Curre			V, V <sub>GS</sub> = 0V		-	-	50	μA	
		-	N	V <sub>DS</sub> = 480V, T <sub>C</sub> = 125°C			-	-	100		
I <sub>GSS</sub>	Gate to	te to Body Leakage Current		V <sub>GS</sub> = ±25	V, V <sub>DS</sub> = 0V		-	-	±10	μA	
On Charac	teristic	S									
V <sub>GS(th)</sub>		reshold Voltage	l.		, I <sub>D</sub> = 250μA		3.0	_	5.0	V	
R <sub>DS(on)</sub>		rain to Source On Res		$V_{GS} = V_{DS}, I_D = 230 \mu A$ $V_{GS} = 10V, I_D = 1.7A$			-	1.9	2.5	Ω	
9FS		d Transconductance		$V_{\rm DS} = 20V, I_{\rm D} = 1.7A$ (Note 4)			-	3.4	-	S	
	h a va atr			00							
Dynamic C		apacitance						385	510	pF	
C <sub>iss</sub>		Capacitance	v	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V			_	40	60	pr	
C <sub>oss</sub> C <sub>rss</sub>		e Transfer Capacitance		f = 1MHz		+	_	3.7	5	pr	
Q <sub>g(tot)</sub>		Gate Charge at 10V					-	8.3	10.8	nC	
Q <sub>gs</sub>		Source Gate Charge	· · · · · · · · · · · · · · · · · · ·	V <sub>DS</sub> = 480	V I <sub>D</sub> = 3.4A		-	2.1	-	nC	
<u>∽gs</u> Q <sub>gd</sub>		o Drain "Miller" Charge		V <sub>GS</sub> = 10V			_	3.3	_	nC	
_		Ū				(Note 4, 5)		0.0			
Switching								40.7	25.4		
t <sub>d(on)</sub>		Delay Time		V = 300	$V_{1-} = 3.4\Delta$	-	-	12.7	35.4	ns	
t <sub>r</sub>		Rise Time		$V_{DD} = 300V, I_D = 3.4A$ $V_{GS} = 10V, R_G = 25\Omega$		-	15.1	40.2	ns		
t <sub>d(off)</sub>		f Delay Time f Fall Time					-	30.2 12.8	70.4 35.6	ns	
t <sub>f</sub>	Turn-Oi					(Note 4, 5)	-	12.0	35.0	ns	
Drain-Sou	rce Dioo	de Characteristic	S						1		
I <sub>S</sub>	Maximum Continuous Drain to Source Dioc						-	-	3.4	Α	
I <sub>SM</sub>		kimum Pulsed Drain to Source Diode Fo					-	-	13.6	A	
V <sub>SD</sub>		Source Diode Forward	-		I <sub>SD</sub> = 3.4A		-	-	1.4	V	
t <sub>rr</sub>		Recovery Time		$V_{GS} = 0V, I_{SD} = 3.4A$ $dI_F/dt = 100A/\mu s$ (Note 4)		-	-	168	-	ns	
Q <sub>rr</sub>	Reverse	Recovery Charge	C			(Note 4)	-	0.7	-	μC	
Notes: 1. Repetitive Ratin	g: Pulse widt	h limited by maximum junctior	n temperature								
2. L = 31mH, I <sub>AS</sub> =	= 3.4A, V <sub>DD</sub> =	50V, $R_G$ = 25 $\Omega$ , Starting $T_J$ =	25°C								
		$D_{DD} \le BV_{DSS}$ , Starting T <sub>J</sub> = 25°	°C								
		)μs, Dual Cycle ≤ 2% perating Temperature Typical	Characteristics								
. Losendally inde	pendent of O	perading reinperature rypical	01101 00101 151105								



25°C -55°C 4 6 8 V<sub>GS</sub>, Gate-Source Voltage[V]

150°C



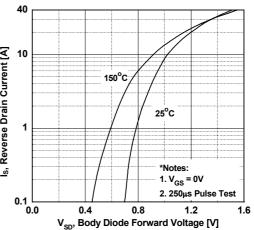
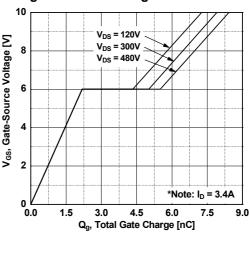
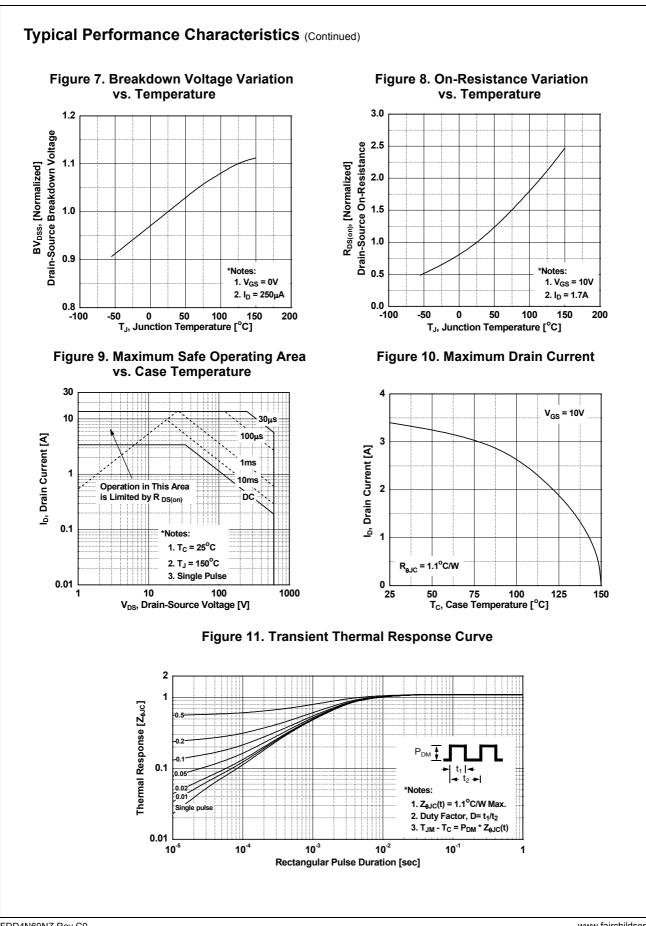
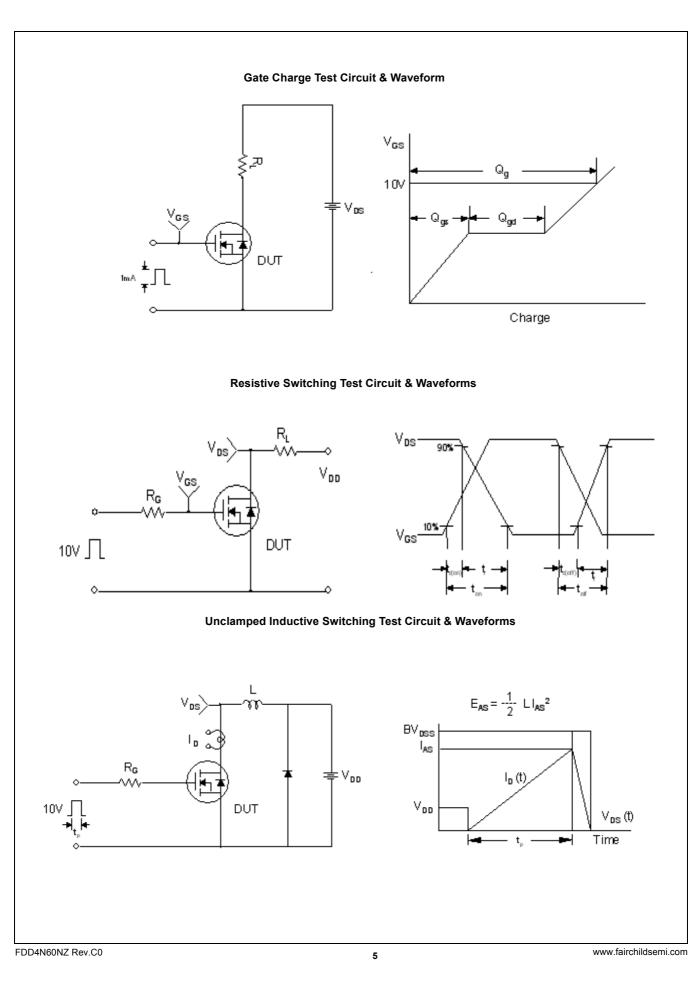


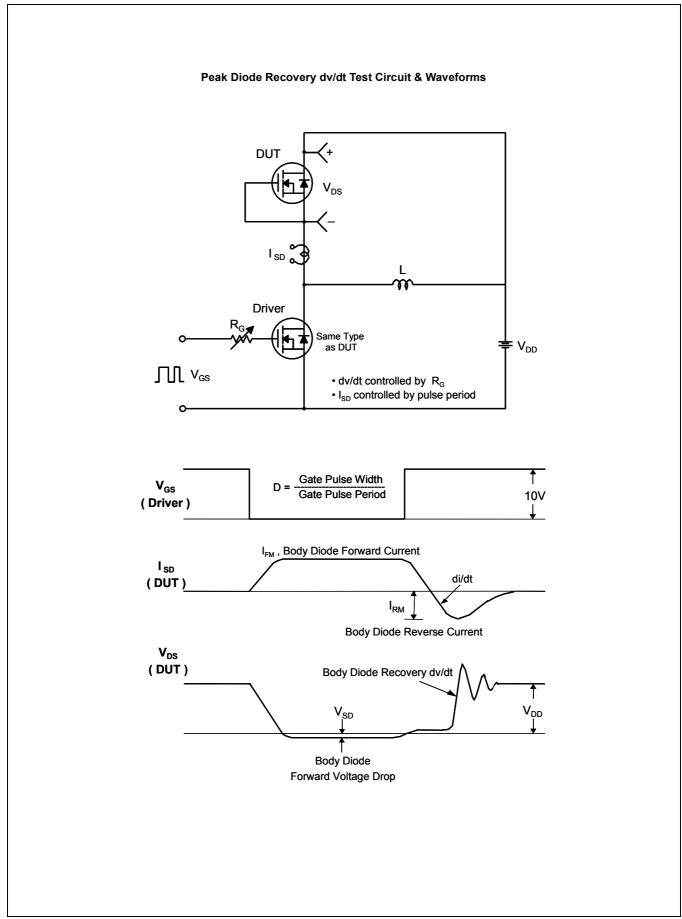
Figure 6. Gate Charge Characteristics

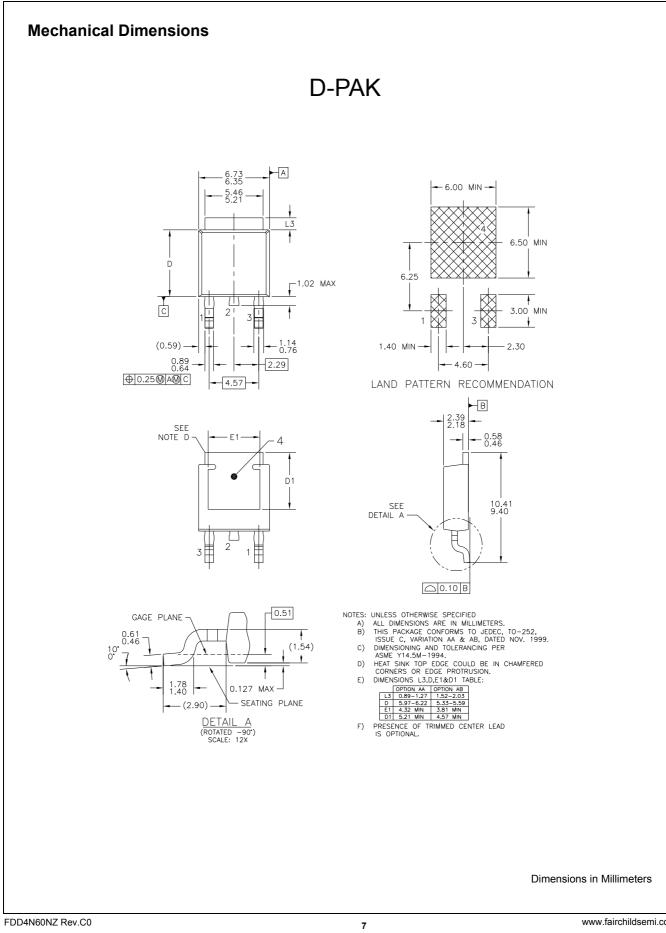




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